

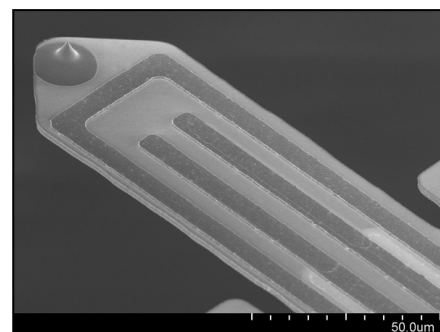
# PRSA-L100-F500-Si-PCB

Silicon piezo-resistive sensing cantilevers

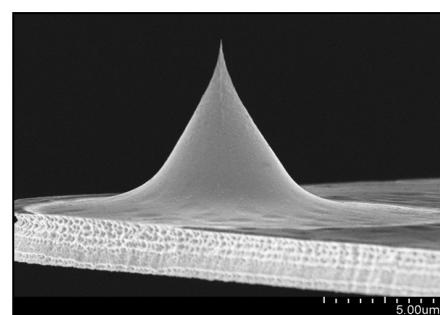


## General description

Piezo-Resistive Sensing Active (PRSA) probes are silicon cantilevers with an integrated piezo-resistor and a heater for self-sensing and self-actuating scanning probe microscopy applications. The piezo-resistors are integrated into a matched Wheatstone bridge to raise the sensitivity and compensate environmental thermal drift. By using the self-sensing readout no laser adjustment is necessary in comparison to conventional optical readout AFM systems. This saves time during a cantilever change. The free space above the cantilever enables new applications and combination of AFM with various instruments. The cantilever chip is bonded to a small printed circuit board (PCB) with a small connector for a quick cantilever change. The counter part PCB for the cantilever PCB can be connected to a low-noise pre-amplifier with a flat flex cable.



Tip side of a PRSA-L100 cantilever with Al tracks for reading out the deflection signal

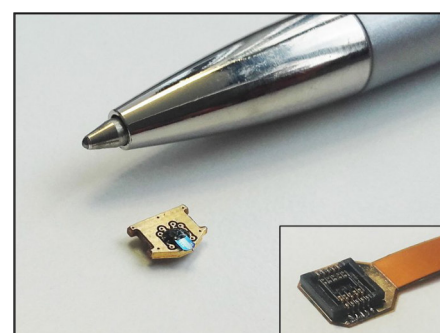


Side view of a PRSA-L100 cantilever

## Specifications

| Model                     | PRSA-L100-F500-Si-PCB  |
|---------------------------|--|
| Tip radius (apex)         | <15 nm   |
| Tip height                | 4...6 $\mu\text{m}$  |
| Tip material              | silicon  |
| Resonant frequency        | 200..800 kHz   |
| Spring constant           | 8...530 N/m  |
| Recomm. AFM mode          | tapping, non-contact   |
| sensitivity*              | 1...3 $\mu\text{V/nm}$   |
| force sensitivity*        | 2.7...530 nN/ $\mu\text{V}$  |
| Length, width             | 110 $\pm$ 5 $\mu\text{m}$ , 48 $\pm$ 2 $\mu\text{m}$   |
| Material                  | silicon cantilever, boron doped 1k Ohm piezo resistors, aluminium tracks                         |
| Deflection sensing        | on chip piezo-resistive bridge   |
| Actuator                  | external shaker or on chip heater (12 +/-3 Ohm)  |
| Electrical connections    | bonded to small PCB with connector (counter part PCB available) or optional bonding pads on chip |
| Chip dimensions (h, w, l) | 0.3 / 1.0 / 2.7 mm   |

\* not amplified, 2.048 V bridge supply

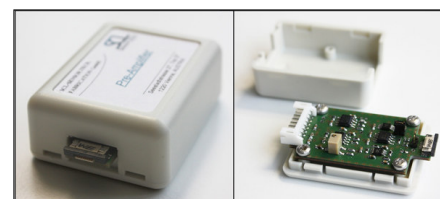


Cantilever is bonded to a 6 x 4.5 mm PCB (height with connector 1.6 mm, complete height connected to CP-PCB: 1.8 mm); right: counter part PCB

## Applications:

- Integration on a standard AFM scanner and high-speed AFM
- Force or deflection measurements within TEM, SEM, XPS, etc.

**What about your application? Contact us!**



Hardware for amplified readout: Low-noise pre-amplifier (45x35 mm)

SCL-Sensor.Tech. Fabrication GmbH

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